

FLIP CHIP PACKAGE  
Application No. 10/681,445  
Inventor: Sung Mao WU et al.  
*Replacement Sheet*

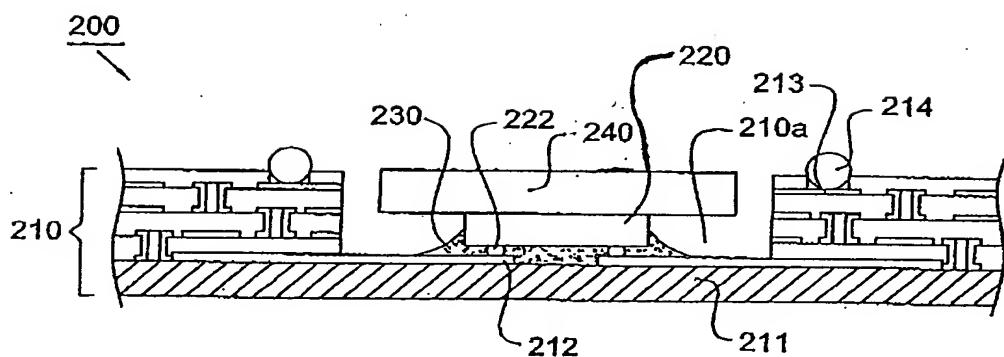


FIG. 2

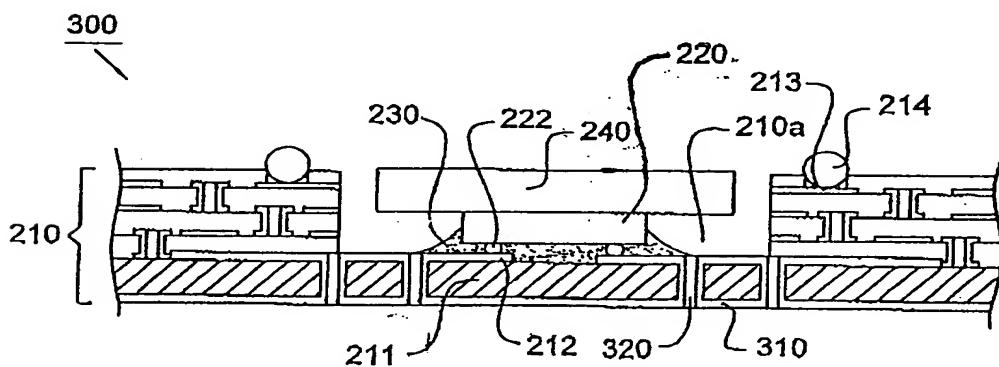


FIG. 3